

## **Surface Mount Schottky Barrier Rectifier**

Reverse Voltage - 40 V Forward Current - 3.0A

## **FEATURES**

- Metal silicon junction, majority carrier conduction
- For surface mounted applications
- Low power loss, high efficiency
- High forward surge current capability
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications



• Case: SOD-123FL

• Terminals: Solderable per MIL-STD-750, Method 2026

• Approx. Weight:15mg 0.00048oz

## **Absolute Maximum Ratings and Electrical characteristics**

 $Ratings\ at\ 25\,^{\circ}\!Cambient\ temperature\ unless\ otherwise\ specified. Single\ phase,\ half\ wave,\ 60Hz\ resistive\ or\ inductive\ load, for\ capacitive\ load,\ derate\ by\ 20\ \%$ 



1:Cathode 2:Anode
Simplified outline SOD-123FL and symbol

Parameter	Symbols	Values	Units
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	40	٧
Maximum RMS voltage	V <sub>RMS</sub>	28	٧
Maximum DC Blocking Voltage	V <sub>DC</sub>	40	V
Maximum Average Forward Rectified Current	I <sub>F(AV)</sub>	3.0	Α
Peak Forward Surge Current,8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I <sub>FSM</sub>	80	А
Max Instantaneous Forward Voltage at 3 A	V <sub>F</sub>	0.55	٧
Maximum DC Reverse Current T <sub>a</sub> = 25°C at Rated DC Reverse Voltage T <sub>a</sub> = 100°C	I <sub>R</sub>	0.3 5	mA
Typical Junction Capacitance <sup>1)</sup>	Cj	160	pF
Typical Thermal Resistance <sup>2)</sup>	R <sub>eJA</sub>	65	°C/W
Operating Junction Temperature Range	Tj	-55 <b>~ +</b> 125	°C
Storage Temperature Range	T <sub>stg</sub>	-55 ~ <b>+</b> 150	°C

 $<sup>1\,)</sup>$   $\,$  Measured at 1MHz and applied reverse voltage of 4 V D.C.

<sup>2)</sup> P.C.B. mounted with 0.2 X 0.2" (5 X 5 mm) copper pad areas.

Fig.1 Forward Current Derating Curve

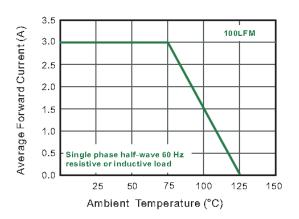


Fig.3 Typical Forward Characteristic

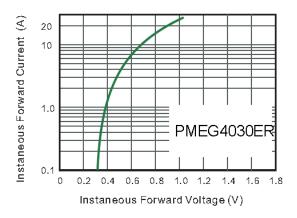


Fig.5 Maximum Non-Repetitive Peak Forward Surage Current

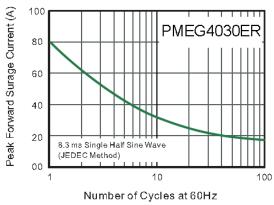


Fig.2 Typical Reverse Characteristics

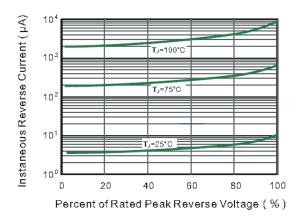


Fig.4 Typical Junction Capacitance

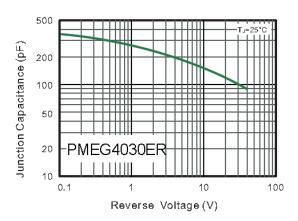
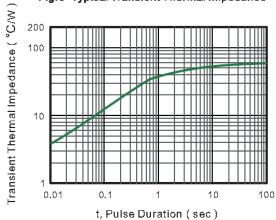


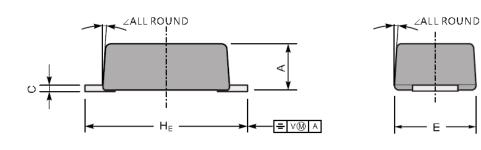
Fig.6- Typical Transient Thermal Impedance

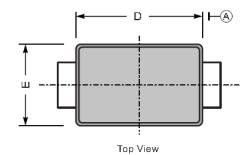


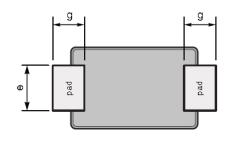
## PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SOD-123FL







Bottom View

UNIT Α С Ε D  $H_{\mathsf{E}}$ е g 1.1 0.20 2.9 1.9 1.1 0.9 max 3.8 mm min 0.9 0.12 2.6 1.7 8.0 0.7 3.5 7° 43 7.9 35 150 max 114 75 43 mil min 35 4.7 102 67 31 28 138

The recommended mounting pad size

